

110-43-640-41-001000

110-43-640-41-001000 Information

	 110-43-640-41-001000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 40POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



110-43-640-41-001000 Specifications

Manufacturer Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors Package - Series 110 Type DIP, 0.6" (15.24mm) Row Spacing Number of Positions or Pins (Grid) 40 (2 x 20) Pitch - Mating 0.100" (2.54mm) Row Spacing Contact Finish - Mating Gold Contact Finish Thickness - Mating 30µin (0.76µm) Contact Material - Mating Beryllium Copper Features Open Frame Pitch - Post 0.100" (2.54mm) Contact Finish Thickness - Mating Solder Contact Material - Mating Beryllium Copper Features Open Frame Contact Material - Mating Solder Contact Finish Thickness - Post 0.100" (2.54mm) Contact Finish - Post 0.100" (2.54mm) Contact Finish Thickness - Post Solder Contact Finish Thickness - Post Solder Contact Finish Thickness - Post 20µin (5.08µm) Contact Finish Thickness - Post Brass Alloy Contact Material - Post Polycyclo			
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Housing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish Thickness - Post	200µin (5.08µm)	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Report errors?	Operating Temperature	-55°C ~ 125°C	
			Report errors?

110-43-640-41-001000 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.

SERVICE BUARANTEE

Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

110-43-640-41-001000 Payment Methods





If you have any question about 110-43-640-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com